



A5133 module specification

MD5133-A02-01 (QFN4x4, 24pin)

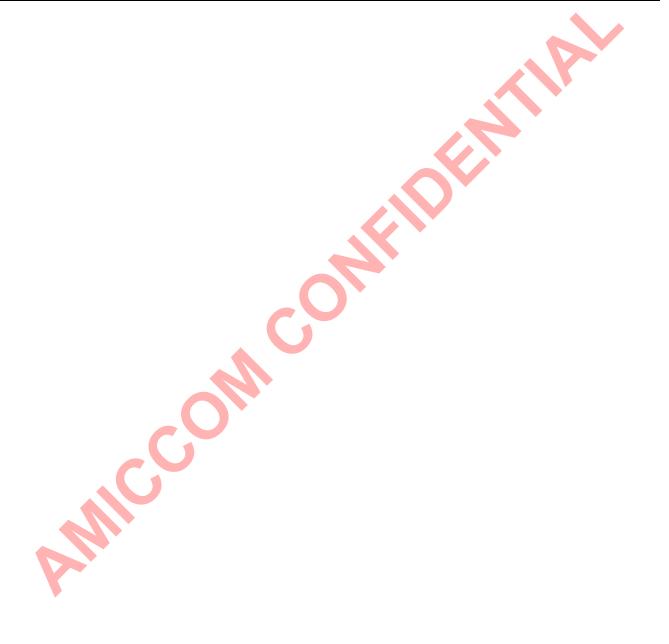
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Revision History

| Rev. No. | History | Issue Date | Remark |
|----------|---------------|------------|-------------|
| 0.0 | Initial issue | Jun., 2022 | Preliminary |
| | MD5133-A02-01 | · | |





General Description

The MD5133-A02 module is designed for 5.8GHz ISM band with 15dBm out power wireless applications using AMICCOM A5133 FSK transceiver. This module features a fully programmable frequency synthesizer by SPI. The maximum data rate is 4Mbps.

Electrical specification

| Item | Specification | Remark |
|-----------------------|---|---------------------|
| Supply voltage | 2.0V~3.6V | |
| | 4 uA @ Sleep mode (IRC on) | |
| | 0.7 mA @ Idle mode | |
| Current consumption | 2.5 mA @ Stand-by mode | Typical |
| Ourient consumption | 13.5 mA @ PLL mode | REGI=3.3V |
| | 33 mA @ Rx mode | |
| | 90 mA @ Tx mode (Pout = 15dBm) | |
| Frequency | 5725 – 5850 MHz | ISM band |
| Transmit output power | 15 dBm (typical) | REGI=3.3V *1, *2 |
| Rx sensitivity | -90 dBm (typical) @DR=4Mbps mode | BER≦1E-3 |
| Modulation | dulation FSK | |
| Interface | | |
| Dimension | 30.7mm(L) x 22.6mm(W) mm ² with PCB antenna (PCB thickness is 0.8mm) | |
| Operating temperature | -40 ~ 85 °C | |

Annotation:

1. Typical setting:

Register [21h] EXT2 (ATG[3:0]=8, page 8) value: 0x2C (TPA: 2)

Register [21h] EXT5 (ATG[3:0]=11, page 11) value: 0x42 (CBBF: 2)

Register [2Ah] DASP6 (ATG[3:0]=6, page 6) value: 0x03 (PA_HCS: 1, PAB_HCS: 1, TXLO_HC:0)

Register [2Dh] TX Test value: 0xA7 (TBF: 7)

2. To pass CE/FCC and the setting as shown below.

Transmit output power = 10dBm.

Register [21h] EXT2 (ATG[3:0]=8, page 8) value: 0x6C (TPA: 6)

Register [21h] EXT5 (ATG[3:0]=11, page 11) value: 0x40 (CBBF: 0)

Register [2Ah] DASP6 (ATG[3:0]=6, page 6) value: 0x00 (PA_HCS: 0, PAB_HCS: 0, TXLO_HC:0)

Register [2Dh] TX Test value: 0xA0 (TBF: 0)



Interface

J1:

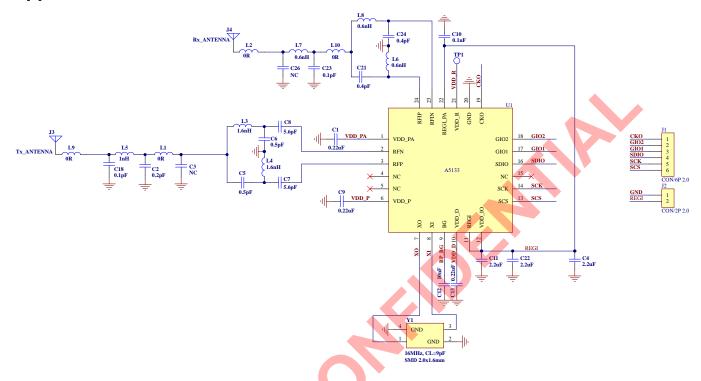
| Pin No. | Symbol | Function Description | Remark |
|---------|--------|-----------------------------|--------|
| 1 | СКО | Multi-function Clock Output | |
| 2 | GIO2 | General Purpose I/O 2 | |
| 3 | GIO1 | General Purpose I/O 1 | |
| 4 | SDIO | SPI Data I/O | |
| 5 | SCK | SPI Clock | |
| 6 | SCS | SPI Chip Selection | |

J2:

| Pin No. | Symbol | Function Description | Remark | | |
|---------|--------|---------------------------------------|--------|--|---------------|
| 1 | GND | Ground | | | |
| 2 | REGI | RF Module supply voltage supply input | | | Typical, 3.3V |



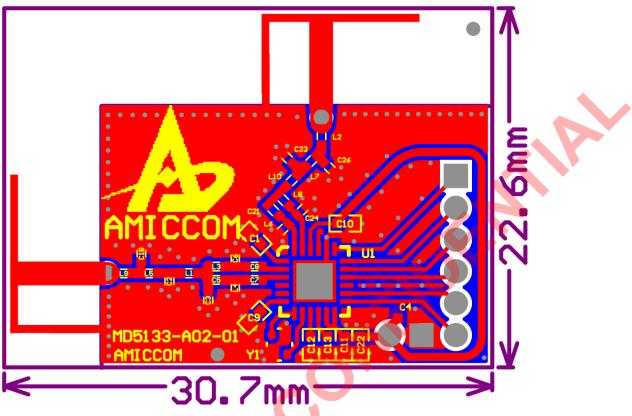
Application Circuit



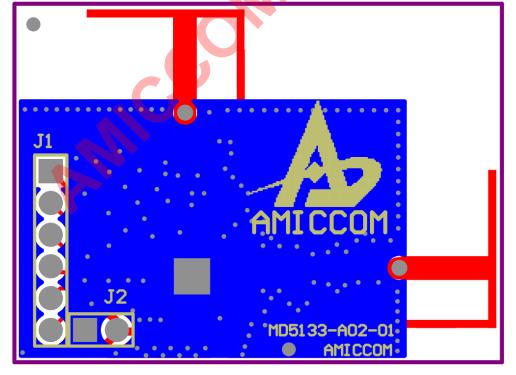
The back plate of the IC should connect to GND



Module dimension drawing (Top view)



Module dimension drawing (Bottom view)



J1: CON/6P 2.0mm J2: CON/2P 2.0mm



Bill of Material

| Item | Component | Description | Size | Value | Tol. | Manufacturer | Manufacturer Number |
|------|-----------|------------------------|------------------|-----------------|---------|--------------|---------------------|
| 1 | C1 | X5R ceramic capacitor | 0402 | 0.22uF | ±10% | Murata | GRM155R61A224K |
| 2 | C2 | C0G ceramic capacitor | 0402 | 0.2pF | ±0.05pF | Murata | GRM1555C1HR20W |
| 3 | C4 | X5R ceramic capacitor | 0402 | 2.2uF | ±10% | Murata | GRM155R61A225K |
| 4 | C5 | C0G ceramic capacitor | 0402 | 0.5pF | ±0.1pF | Murata | GRM1555C1HR50B |
| 5 | C6 | C0G ceramic capacitor | 0402 | 0.5pF | ±0.1pF | Murata | GRM1555C1HR50B |
| 6 | C7 | C0G ceramic capacitor | 0402 | 5.6pF | ±0.25pF | Murata | GRM1555C1H5R6C |
| 7 | C8 | C0G ceramic capacitor | 0402 | 5.6pF | ±0.25pF | Murata | GRM1555C1H5R6C |
| 8 | С9 | X5R ceramic capacitor | 0402 | 0.22uF | ±10% | Murata | GRM155R61A224K |
| 9 | C10 | X7R ceramic capacitor | 0402 | 0.1uF | ±10% | Murata | GRM155R71C104K |
| 10 | C11 | X5R ceramic capacitor | 0402 | 2.2uF | ±10% | Murata | GRM155R61A225K |
| 11 | C12 | X7R ceramic capacitor | 0402 | 10nF | ±10% | Murata | GRM155R71H103K |
| 12 | C13 | X5R ceramic capacitor | 0402 | 0.22uF | ±10% | Murata | GRM155R61A224K |
| 13 | C18 | C0G ceramic capacitor | 0402 | 0.1pF | ±0.05pF | Murata | GRM1555C1HR10W |
| 14 | C21 | C0G ceramic capacitor | 0402 | 0.4pF | ±0.05pF | Murata | GRM1555C1HR40W |
| 15 | C22 | X5R ceramic capacitor | 0402 | 2.2uF | ±10% | Murata | GRM155R61A225K |
| 16 | C23 | C0G ceramic capacitor | 0402 | 0.1pF | ±0.05pF | Murata | GRM1555C1HR10W |
| 17 | C24 | C0G ceramic capacitor | 0402 | 0.4pF | ±0.05pF | Murata | GRM1555C1HR40W |
| 18 | L1 | Chip resistor | 0402 | 0 ohm | | | |
| 19 | L2 | Chip resistor | 0402 | 0 ohm | | | |
| 20 | L3 | Chip inductor | 0402 | 1.6nH | ±0.3nH | Murata | LQG15HS1N6S |
| 21 | L4 | Chip inductor | 0402 | 1.6nH | ±0.3nH | Murata | LQG15HS1N6S |
| 22 | L5 | Chip inductor | 0402 | 1nH | ±0.3nH | Murata | LQG15HS1N0S |
| 23 | L6 | Chip inductor | 0402 | 0.6nH | ±0.1nH | WLCM | 0603TGB0N5TB |
| 24 | L7 | Chip inductor | 0402 | 0.6nH | ±0.1nH | WLCM | 0603TGB0N5TB |
| 25 | L8 | Chip inductor | 0402 | 0.6nH | ±0.1nH | WLCM | 0603TGB0N5TB |
| 26 | L9 | Chip resistor | 0402 | 0 ohm | | | |
| 27 | L10 | Chip resistor | 0402 | 0 ohm | | | |
| 28 | U1 | Transceiver IC | QFN 4x4 24pin | | | AMICCOM | A51U33AQCI |
| 29 | Y2 | SMD Crystal Oscillator | SMD 2.0x1.6mm | 16MHz CL=9pF | ±20ppm | TST | TZ23157 |

Annotation:

1. C3, C26 are NC